

# APPLICATION NOTE

MITSUBISHI<IGBT MODULE>

## Tentative

## CM600HB-24A

Pre.	H.Hanada	Rev	A	H.Hanada, M.Konice
Apr.	T.Furuie 07-Oct-'03			T.Furuie 04-Nov-'03

HIGH POWER SWITCHING USE

### CM600HB-24A

- $I_c$  ..... 600A
- $V_{CES}$  ..... 1200V
- Insulated Type
- 1-elements in a pack

### APPLICATION

AC drive inverters & Servo controls,etc

### ABSOLUTE MAXIMUM RATINGS ( $T_j = 25^\circ\text{C}$ )

Symbol	Item	Conditions	Ratings	Units
$V_{CES}$	Collector-emitter voltage	G-E Short	1200	V
$V_{GES}$	Gate-emitter voltage	C-E Short	$\pm 20$	V
$I_c$	Collector current	DC, $T_c = 80^\circ\text{C}$ *1	600	A
		Pulse (2)	1200	
$I_E$ (1)	Emitter current		600	A
		Pulse (2)	1200	
$P_c$ (3)	Maximum collector dissipation	$T_c = 25^\circ\text{C}$ *1	3670	W
$T_j$	Junction temperature		-40~+150	$^\circ\text{C}$
$T_{stg}$	Storage temperature		-40~+125	$^\circ\text{C}$
$V_{iso}$	Isolation voltage	Main terminal to base plate, AC 1 min.	2500	V
—	Torque strength	Main terminal M6	1.96 ~ 2.94	N·m
—	Torque strength	Mounting holes M6	1.96 ~ 2.94	N·m
—	Torque strength	G(E) terminal M4	0.98 ~ 1.47	N·m
—	Weight	Typical value	560	g

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ELECTRICAL CHARACTERISTICS ( $T_j = 25^\circ\text{C}$ )

Symbol	Item	Conditions	Min.	Typ.	Max.	Units
$I_{CES}$	Collector cutoff current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}$	—	—	1	mA
$V_{GE(\text{th})}$	Gate-emitter threshold voltage	$I_C=60\text{mA}, V_{CE}=10\text{V}$	6	7	8	V
$I_{GES}$	Gate leakage current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}$	—	—	0.5	$\mu\text{A}$
$V_{CE(\text{sat})}$	Collector to emitter saturation voltage	$T_j = 25^\circ\text{C}$	$I_C = 600\text{A}$	—	2.1	3.0
		$T_j = 125^\circ\text{C}$	$V_{GE}=15\text{V}$	—	2.4	—
$C_{IES}$	Input capacitance	$V_{CE}=10\text{V}$ $V_{GE}=0\text{V}$	—	—	105	A nF A
$C_{OES}$	Output capacitance		—	—	9	
$C_{RES}$	Reverse transfer capacitance		—	—	2.0	
$Q_G$	Total gate charge	$V_{CC}=600\text{V}, I_C=600\text{A}, V_{GE}=15\text{V}$	—	3000	—	nC
$t_{d(on)}$	Turn-on delay time	$V_{CC}=600\text{V}, I_C=600\text{A}$ $V_{GE1}=V_{GE2}=15\text{V}$ $R_G=0.52\Omega$ , Inductive load switching operation $I_E=600\text{A}$	—	—	660	ns
$t_r$	Turn-on rise time		—	—	190	
$t_{d(off)}$	Turn-off delay time		—	—	700	
$t_f$	Turn-off fall time		—	—	350	
$t_{rr} \text{ (1)}$	Reverse recovery time		—	—	250	ns
$Q_{rr} \text{ (1)}$	Reverse recovery charge		—	19	—	$\mu\text{C}$
$V_{EC} \text{ (1)}$	Emitter-collector voltage	$I_E=600\text{A}, V_{GE}=0\text{V}$	—	—	3.8	V
$R_{th(j-c)Q}$	Thermal resistance	IGBT part *1	—	—	0.034	°C/W
$R_{th(j-c)R}$		FWDi part *1	—	—	0.051	
$R_{th(c-f)}$	Contact thermal resistance	Case to fin, Thermal compound Applied *2	—	0.02	—	
$R_G$	External gate resistance		0.52	—	7.8	$\Omega$

\*1:  $T_c, T_f$  measured point is just under the chips.

\*2: Typical value is measured by using Shin-etsu Silicone "G-746".

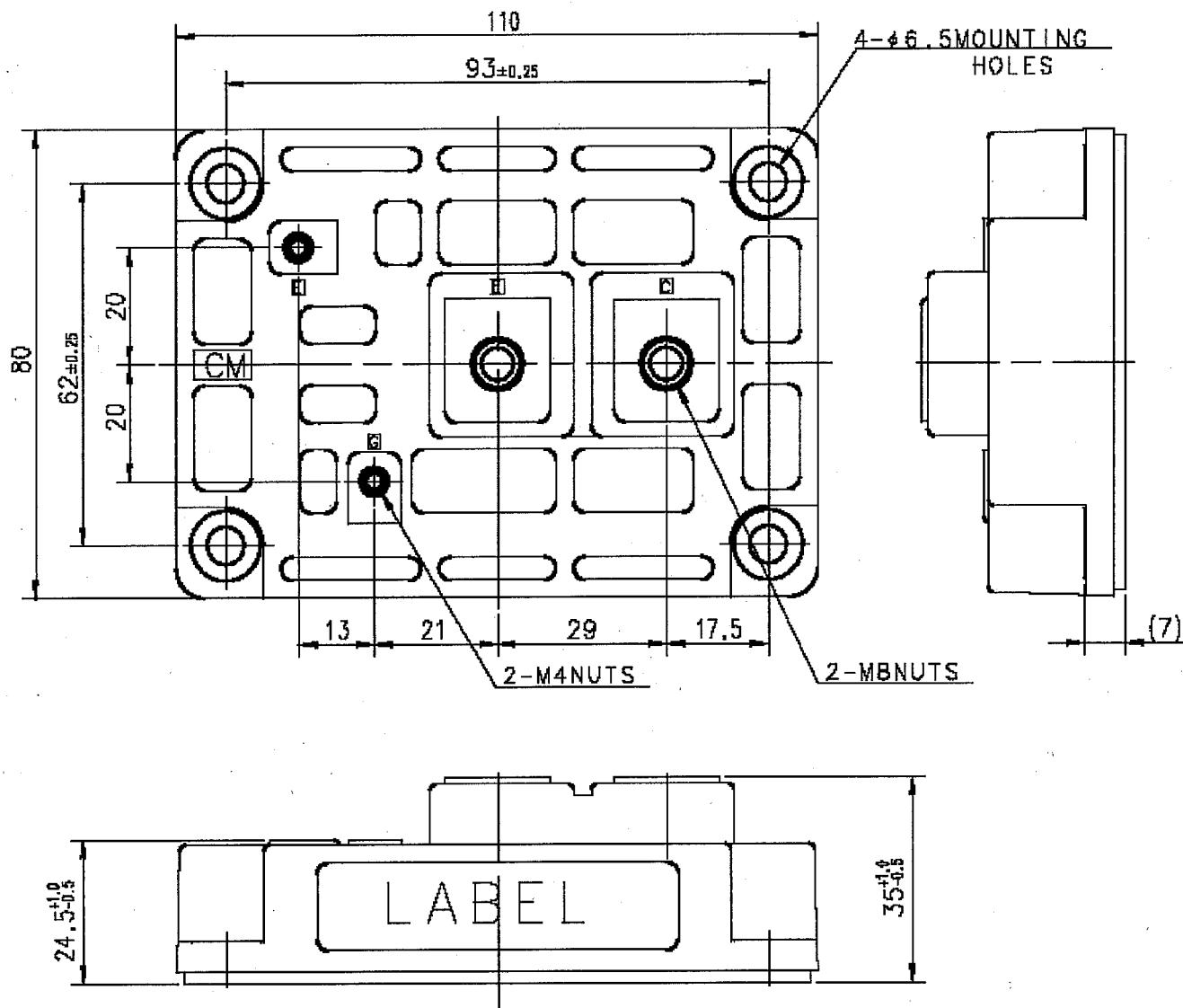
- ①  $I_E, V_{EC}, t_{rr}$  &  $Q_{rr}$  represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWDi).
- ② Pulse width and repetition rate should be such that the device junction temp. ( $T_j$ ) dose not exceed  $T_{jmax}$  rating.
- ③ Junction temperature ( $T_j$ ) should not increase beyond  $150^\circ\text{C}$ .
- ④ Pulse width and repetition rate should be such as to cause negligible temperature rise.

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HIGH POWER SWITCHING USE

## OUTLINE DRAWING

Dimensions in mm



## CIRCUIT DIAGRAM

